

WHAT IS CLAIMED IS:

1. A circuit device comprising,
a conductive pattern, which is formed in inside layer of a dielectric substrate, an earthed conductor, which is formed in outside layer of said dielectric substrate, and said conductive pattern determines the frequency characteristic, and changing the area and position of said earthed conductor provides the desired frequency characteristic.
2. A circuit device as claimed in claim 1, comprising a pattern formed on said earthed conductor, and that enables to change the area and position of the earthed conductor.
3. A circuit device as claimed in claim 2, comprising said pattern, which formed one side, or plural sides of outside layer of said dielectric substrate.
4. A circuit device as claimed in claim 3, comprising a same or different pattern, which is formed one side, or plural sides of outside layer of said dielectric substrate.
5. A circuit device as claimed in claim 2, comprising a said pattern having a lattice shaped said earthed conductor.
6. A circuit device as claimed in claim 2, comprising a said pattern forming one rectangle-shaped and not earthed conductor area or plural areas on said earthed conductor.
7. A circuit device as claimed in claim 2, where in said pattern is thinner than said earthed conductor and forms a non earthed conductor

area in cutting it.

8. A printed board comprising,

a circuit device part having a conductive pattern which is formed in inside layer of the first area of a dielectric substrate, an earthed conductor which is formed in outside layer of the first area of said dielectric substrate, where in said circuit device part provides desired frequency characteristic by setting up the frequency characteristic by said conductive pattern and changing the area and position of said earthed conductor,

a mounted circuit part having a signal processing circuit for processing a desired frequency characteristic signal, which formed on different, the first area of said dielectric substrate.

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